

## TC16-161TX+

Mini-Circuits

50Ω 0.6 to 160 MHz

#### **FEATURES**

- Plastic base with solder plated leads
- Excellent amplitude unbalance, 0.1dB typ.and phase unbalance, 0.5 deg. typ.

#### **APPLICATIONS**

- Impedance matching
- Balanced amplifier



Generic photo used for illustration purposes only CASE STYLE: AT1521

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

#### **ELECTRICAL SPECIFICATIONS AT +25°C**

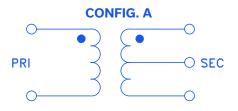
Parameter	Condition	Min.	Тур.	Max.	Unit
Impedance Ratio (secondary / primary)			16		Ohm
Frequency Range		0.6		160	MHz
	0.6-160		3		
Insertion Loss*	1.5-120		2		dB
	3-80		1		

 $^{\ast}$  Insertion Loss is referenced to mid-band loss, 0.7 dB typ.

#### **MAXIMUM RATINGS**

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.



REV. B ECO-021763 TC16-161T+ MCL NY 240506

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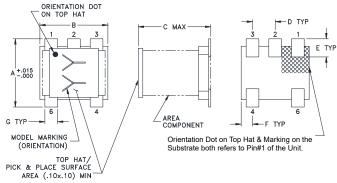
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#### **PIN CONNECTIONS**

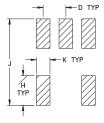
Function	Pin Number
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
SECONDARY CT	2
NOT USED	5



**OUTLINE DRAWING** 

Top-hat total thickness: .013 inches MAX.

#### PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

#### OUTLINE DIMENSIONS (Inch)

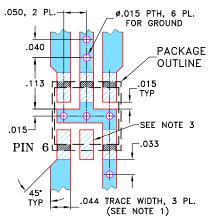
Α	В	С	D	Е	F	G	н	J	K
.150	.150	.160	.050	.040	.025	.028	.065	.190	.030
3.81	3.81	4.06	1.27	1.02	0.64	0.71	1.65	4.83	0.76
	o								

Weight: 0.15 grams

#### **TAPE & REEL INFORMATION: F17**

**PRODUCT MARKING: FK** 

#### DEMO BOARD MCL P/N TB-145 SUGGESTED PCB LAYOUT (PL-244)



 TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER) DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

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**RF** Transformer

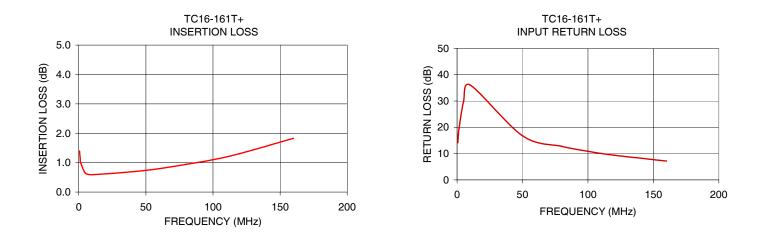


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#### 50Ω 0.6 to 160 MHz

#### **TYPICAL PERFORMANCE DATA**

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.60	1.40	14.15
1.00	1.16	17.14
1.50	0.99	19.51
5.00	0.64	29.93
10.00	0.59	36.06
50.00	0.74	16.77
80.00	0.94	12.74
100.00	1.10	10.87
120.00	1.31	9.38
160.00	1.83	7.18



#### NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

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## **RF Transformer**

Typical Performance Data

FREQUENCY	INSERTION LOSS	RETURN LOSS
(MHz)	(dB)	(dB)
(	(42)	(42)
0.60	1.40	14.15
0.70	1.32	15.05
0.80	1.26	15.87
0.90	1.20	16.54
1.00	1.16	17.14
1.50	0.99	19.51
2.00	0.89	21.30
3.00	0.76	24.39
5.00	0.64	29.93
7.00	0.59	35.13
9.00	0.58	36.48
10.00	0.59	36.06
20.00	0.61	25.85
30.00	0.65	21.51
40.00	0.69	18.85
50.00	0.74	16.77
60.00	0.80	15.16
70.00	0.86	13.86
80.00	0.94	12.74
90.00	1.02	11.74
100.00	1.10	10.87
110.00	1.20	10.08
120.00	1.31	9.38
130.00	1.43	8.74
140.00	1.55	8.17
150.00	1.69	7.66
160.00	1.83	7.18



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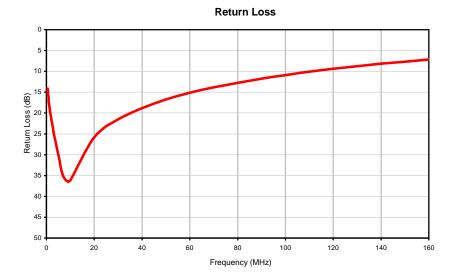
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## **RF** Transformer

Typical Performance Curves







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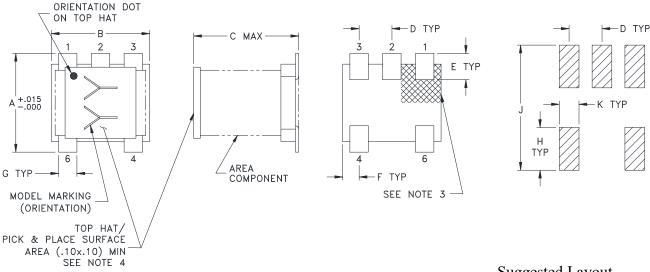
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## Case Style

### **Outline Dimensions**

**PCB Land Pattern** 

AT1521



Suggested Layout, Tolerance to be within ±.002

CASE #	А	В	С	D	Е	F	G	Н	J	K	WT. GRAMS
AT1521	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (.64)	.028 (.71)	.065 (1.65)	.190 (4.83)	.030 (.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. + .01; 3 Pl. + .005

#### Notes:

- 1. Case material: Plastic.
- 2. Termination finish:
  - For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
- 3. Orientation Dot on Top Hat & Marking on the Substrate both refers to Pin #1 of the Unit.
- 4. Top-Hat total thickness: .013 inches MAX.



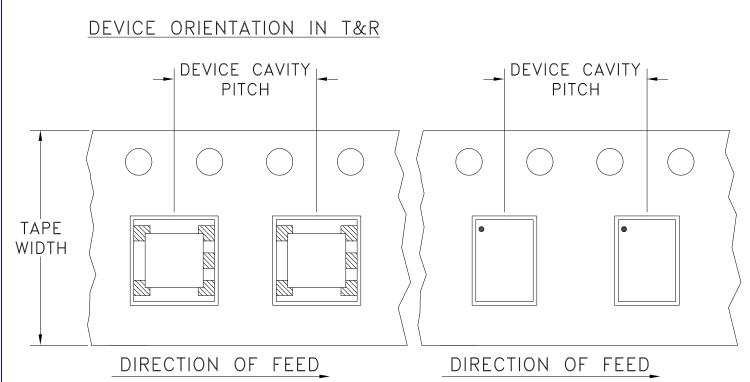


P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com



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# Tape & Reel Packaging TR-F17



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices	s per Reel
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		13	Standard	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



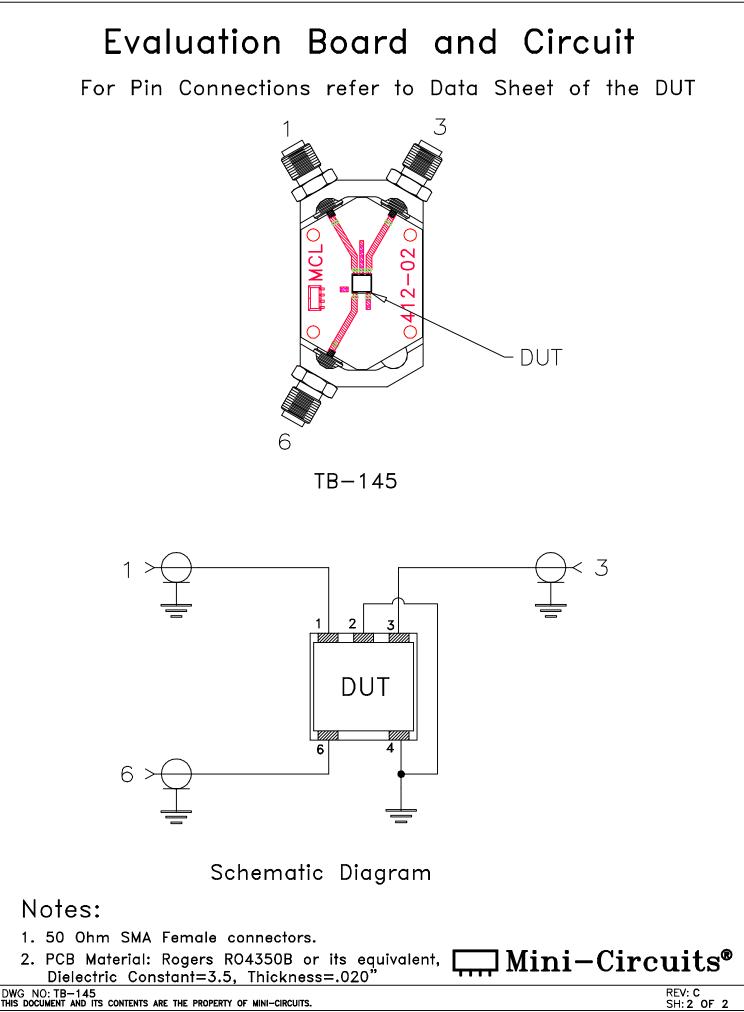


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FOR AT224/DB						2		
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.050, 2 PL. FOR GROUND .040 .040 .040 .015 PACKAGE OUTLINE .113 .015 TYP .015 PIN 6								
NOTES: 1. TRACE WID	45° TYP .044 TRACE WIDTH, 3 PL. (SEE NOTE 1)							
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE. 3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE. DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER) DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK								
UNLESS OTHERWISE SPECIFIED INITIALS DATE DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± .005 APPROVED IG 08/23/06 APPROVED IG 08/23/06								
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ASHEETA1.DWG	REV:A DATE:01/12/95		8PL244	SCALE: 8:1		OF	1	



## Mini-Circuits

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B 02/25/11 M130240 File: ENV02T1.pdf

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